Data Sheet

SPB800S

WiFi SMD Board

H&D Wireless

Revision History

Revision	Revision date	Description
PA1	2010-07-14	First Draft
PA2	2010-10-22	Updated pin and signal list
PA3	2010-11-08	Added evaluation kit information
PA4	2010-11-25	Revised land pattern
PA5	2010-12-10	Land pattern dimensions clarified
PA6	2010-12-13	Land pattern drawing updated
PA7	2010-12-17	FCC ID added
PA8	2010-12-17	Cleaned up pagination
PA9	2011-01-27	Pin list revised
PA10	2011-01-28	Spb800-e x ref table corrected.
PA11	2012-02-09	Updated for release 1.3
PA12	2012-04-25	Added mechanical data for socket version
PA13		
PA14		
PA15	2012-06-08	LED functions claryfied

CONTENTS

1 INTRODUCTION

1.1 Overview

SPB800 is a SMD module with the H&D Wireless' WLAN System In Package, SIP module and a micro processor including external flash memory and peripheral components required. It is a complete solution designed to be function as a standalone communication module, serial cable replacement or as an easy to use WLAN addition with a minimal resource need, to an existing system.

SPB800 features a WLAN Access Point mode ideal for configuration of Wireless LAN, IP, and other system parameters to be set by the user via web page.

SPB800 enables a cost efficient ultra low power, high performance and feature rich client solution. It provides up to 54 Mbit/s data rate when operating in the OFDM mode and up to 11 Mbit/s data rate when operating in the DSSS/CCK mode. The SPB800 offloads all the IP-stack and WiFi-handling porting the serial port of a host to a TCP socket.

The SPB800 functions in two modes

- Serial WiFi adapter with UART interface. Intended for stationary non-battery operated system.
- WLAN addition to a system using the (o)WL-pico API that requires a minimum footprint on the host processor. Optimized for battery powered systems.

This data sheet pertains to the SPB800S, the Serial_to_WiFi mode in regards to pin out and features. For (o)WL-pico pinning please refer to the 1451-SPB800P_datasheet.

1.2 Key Features

Integrated IP-stack
Data Rates: 1, 2, 5.5, 6, 9, 11, 12, 18, 24, 36, 48, and 54Mbps
Modulation: QPSK, 16QAM, 64QAM DBPSK, DQPSK, CCK, OFDM with BPSK
WEP, WPA and WPA2 Supported
Works in Soft AP or station mode
Low power consumption
Advanced power management for optimum power consumption at varying load.
Single Supply Voltage 3.3 V
Small footprint
22 x 34 mm (866 x 1338 mil) bottom pad version.
RoHS Compliant
Integrated Chip antenna or U.FL connector versions available
Evaluation kits available.

2 HARDWARE ARCHITECTURE

2.1 Block Diagram

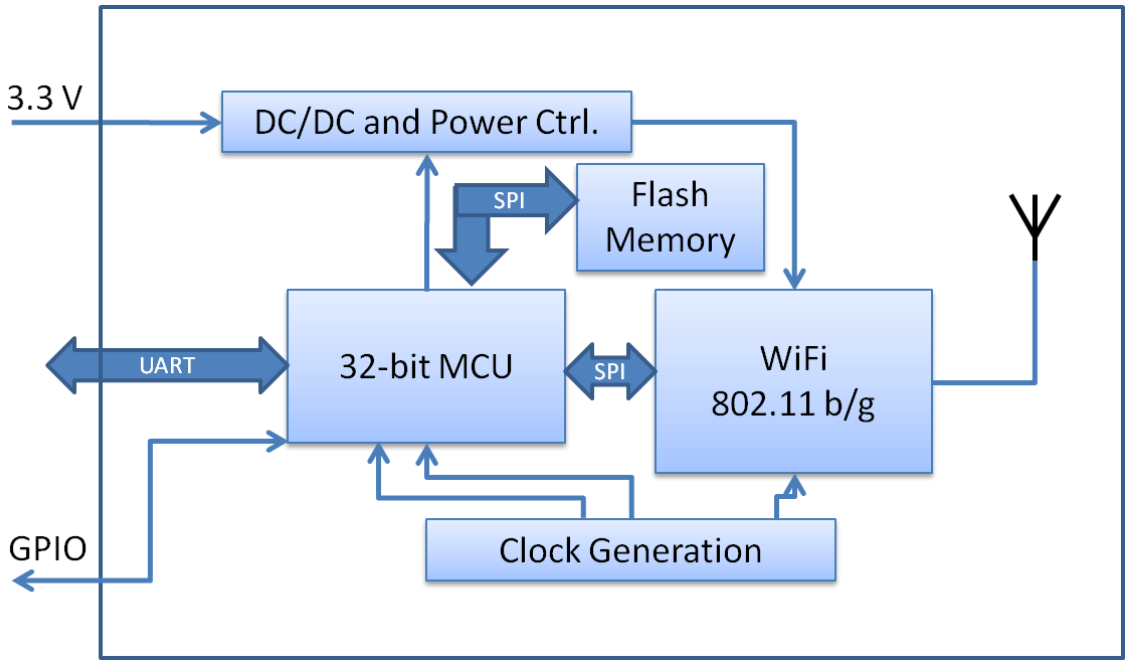


Figure 2-1 Block Diagram:

2.2 Order information

EXAMPLE: **SPB800P - B C P 1**

Product Family
SPB800

Firmware pre-programming
P = (o)WL-pico Server
S= Serial_to_WiFi

Antenna Option
B= Intergrated Chip Antenna
D= U.fl RF connector

Operating Temperature
C= 0°C - 70°C
M= -40°C - 85°C

Package
P= 42 pin SMD module, bottom pads
M= 10 pin socket 2x5, 2.54 mm pitch

Delivery Package
1= ESD bag
2= Tape & Reel
3= Tray

3 ELECTRICAL DATA

3.1 Absolute maximum ratings

Rating	Min	Max	Unit
Supply voltage	0	4	V
Input RF level		10	dBm
Storage temperature	-50	+125	°C

Table 3-1: Abolute maximum ratings. Exceeding any of the maximum ratings, even briefly lead to deterioration in performance or even destruction. Values indicates condition applied one at the time.

3.2 Electro Static Discharge (ESD)

SPB800 withstands ESD voltages up to 2000V HBM (Human Body Model) according to JESD22-A114 and up to 300V MM (Machine Model) according to JESD22-A115.

3.3 Recommended operating conditions

Symbol		Min	Typ.	Max	Unit
VCC	Supply Voltage	3.0	3.3	3.6	V
V_{IHH}	High Input Tolerant Pins, UART_TX UART_RX, UART_CTS, UART_RTS	2.0		5.0	V
V_{IHN}	All other input pins	2.0		3.6	V
V_{IL}	All pins	-0.3		0.8	V
T_{OP}	Operating temperature class ”C”	0	+25	+70	°C
T_{OP}	Operating temperature class ”M”	-40	+25	+85	°C

Table 3-2: Recommended operating conditions

3.4 Power Consumption

3.4.1 Current Consumption

Mode	Conditions	Parameter	Voltage	Min	Typ.	Max	Unit
All modes		VCC	3.6 V			300	mA
TX [802.11b]	25ºC	VCC	3.3 V		240	270	mA
TX [802.11g]	25ºC	VCC	3.3 V		200	230	mA

RX [802.11b]	25ºC	VCC	3.3 V		120		mA
RX [802.11g]	25ºC	VCC	3.3 V		110		mA
Power Save (2s beacons)	25ºC	VCC	3.3 V		35		mA
Shutdown	25º	VCC	3.3 V		50.0		nA

Table 3-3: Current consumption in different modes.

3.4.2 Power Consumption

Conditions: T_{amb}=25°C, VCC=3.3 V

Mode	Output Power	Power Consumption	Comments
TX 802.11b	+17 dBm	790 mW	1, 2, 5.5, 11 Mbit/s, MCU run at 48 MHz
TX 802.11g	+14 dBm	654 mW	6, 9, 12, 18, 24, 36, 48, 54 Mbit/s, MCU run at 48MHz
RX 802.11b	N/A	284 mW	MCU run at 48 MHz
RX 802.11g	N/A	294 mW	MCU run at 48 MHz
Soft AP	+17dBm	430mW	One station connected
Power Save	N/A	115 mW	Receive only, 2s RX beacons, MCU in idle, 48 MHz
Shutdown	N/A	0,0016 mW	System off*

Table 3.4: Power consumption in different modes.
* SPB800E or recommended design, see Figure 5-2

3.5 RF Performance

VCC= 2.75 – 3.6V, Tamb= -40 to +85°C, RF signal level referred to antenna port

Parameter	Conditions	Min	Typical	Max	Units
Frequency range		2400		2500	MHz
RF impedance			50		ohm
Transmitter performance[1]					
Output power	QPSK, Calibrated.	+16,5	+17	+17,5	dBm
Output power	OFDM 54Mbit/s, Calibrated.	+13	+14	+14,5	dBm
EVM at +15dBm	QPSK		15	35	%
EVM at +11dBm	OFDM 54MBit/s		3.5	5.6	%
Receiver performance, Tamb 27°C					
Receiver sensitivity	DPSK 1Mbit/s		-96		dBm
Receiver sensitivity	QDPSK 2Mbit/s		-92		dBm
Receiver sensitivity	CCK/DPSK 5.5Mbit/s		-91		dBm
Receiver sensitivity	CCK/BPSKK 11Mbit/s		-88		dBm
Receiver sensitivity	OFDM 6Mbit/s		-91		dBm
Receiver sensitivity	OFDM 9Mbit/s		-90		dBm
Receiver sensitivity	OFDM 12Mbit/s		-88		dBm
Receiver sensitivity	OFDM 18Mbit/s		-86		dBm
Receiver sensitivity	OFDM 24Mbit/s		-83		dBm
Receiver sensitivity	OFDM 36Mbit/s		-80		dBm
Receiver sensitivity	OFDM 48Mbit/s		-76		dBm
Receiver sensitivity	OFDM 54Mbit/s		-74		dBm

Table 3.5: RF performance.

1) TX output power varies with temperature as shown in Figure 3-1

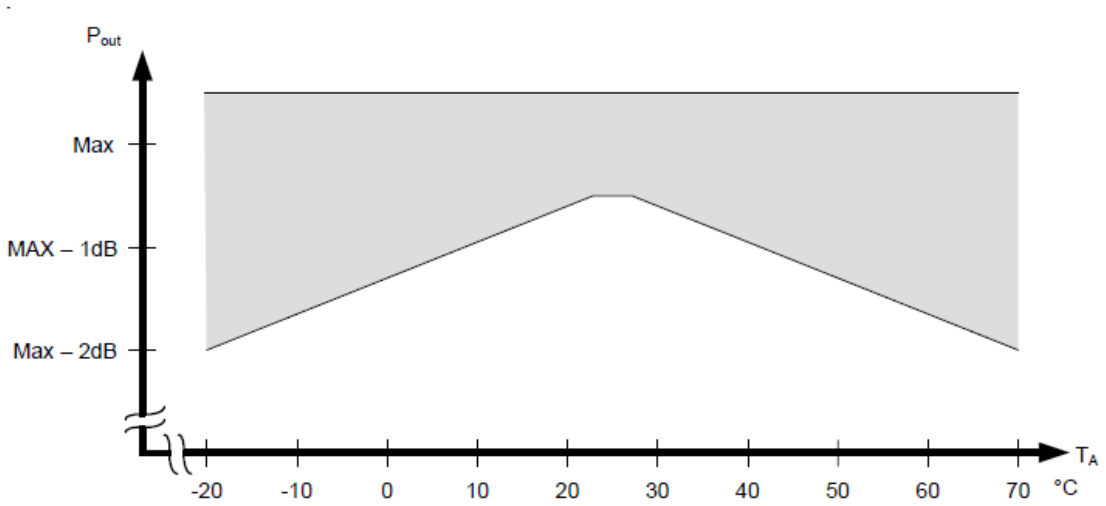


Figure 3-1: Pout vs. ambient temperature

3.6 Throughput

The user data throughput is dependent on the set baud rate of the UART port and but is limited by hardware to 112kbps.

4 PIN CONFIGURATIONS

4.1 Pin Configuration bottom pad version

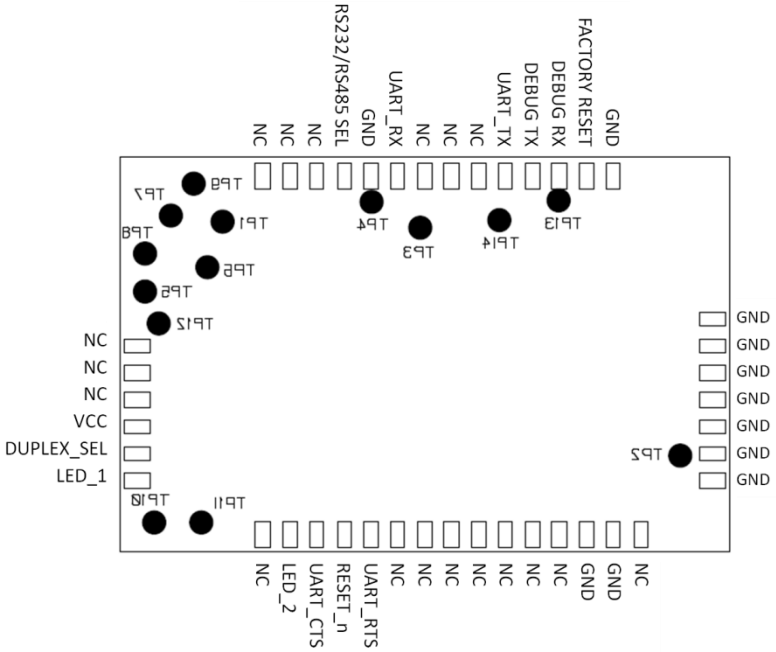


Figure 4-1: Module pads bottom pads version, Top view. Test points used in production test.

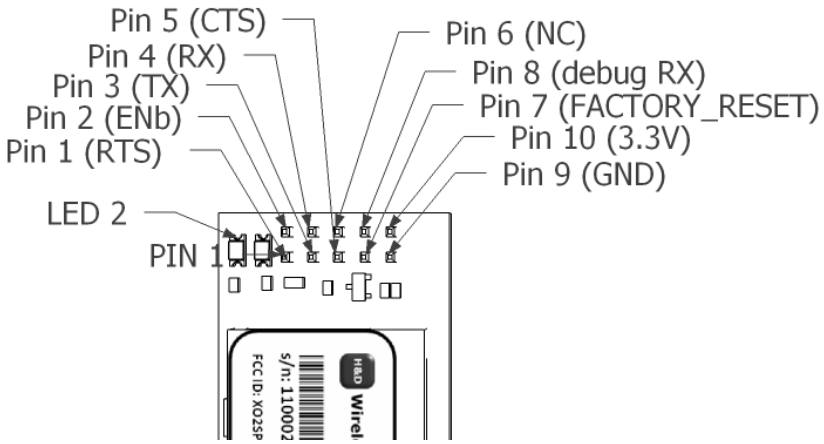


Figure 4-2: Pin out on SPB800-xxM module and the SPB800-E with 2.54 mm socket, Note that the LEDs are only mounted on SPB800-E evaluation kit

4.2 Pin assignments

Pin SPB800	Pin SPB800-E SPB800-xxM	Function	Type	Description
1	-	NO CONNECTION	NC	Do not connect
2	On board	LED_2	O	Indicates IP address acquired [1] (active low)
3	5	UART_CTS	I	Clear to send (active low)
4	-	RESET_n	I	Reset of the SPB800 MCU (active low)
5	1	UART_RTS	O	Ready to send (active low)
6 -12	-	NO CONNECTION	NC	Do not connect
13	9	GND	S	Ground
14	9	GND	S	Ground
15	-	NO CONNECTION	NC	Do not connect
16-23	9	GND	S	Ground
24	7	FACTORY_RESET	I	Active Low, Restores factory default setting. Internal Pull up
25	8	DEBUG_RX	I	Serial port for production test leave unconnected
26	-	DEBUG_TX	O	Serial port for production test leave unconnected
27	3	UART_TX	O	UART TX
28-30	-	NO CONNECTION	NC	Do not connect
31	4	UART_RX	I	UART RX
32	9	GND	S	Ground
33	-	RS232/RS485_SEL	O	Control signal for RS232 or RS485 mode selection
34	6	NC CONNECTION	O	Do not connect
35-39	-	NO CONNECTION	NC	Do not connect
40	10	VCC	S	3.3V supply voltage
41	-	DUPLEX_SEL	O	Control signal for duplex selection
42	On Board	LED_1	O	Indicates WiFi Connection[1] (active low)

Table 4-1: Pin Description for the module

1) LED functions may vary depending on firmware and mode.

5 APPLICATION INFORMATION

5.1 Power Supply

SPB800 must be powered by a 3.3V supply on the VCC pin.

5.2 Initialization

After the SPB800 has been powered there is a 200ms initialization time before communication with the module can be initiated.

5.3 UART Serial interface

To communicate with the SPB800 a UART interface is used. The signals “UART_RTS” and “UART_CTS” are only active when hardware flow control is enabled by setting the data base parameter /uart/rtscts.

The configurable and supported baud rates are:
300, 1200, 2400, 4800, 9600, 19200, 38400, 57600, 115200 and 230400 baud.

5.4 RS232/RS485_SEL Signal

The RS232/RS485_SEL signal is an output signal that can be used for control of an external converter circuit. It is controlled by the /uart/mode parameter.

/uart/mode	RS232/RS485_SEL
RS232	Low
RS485	High

5.5 DUPLEX_SEL Signal

The DUPLEX_SEL signal is an output signal that can be used for control of an external converter circuit. It is controlled by the /uart/duplex parameter.

/uart/duplex	DUPLEX_SEL
half	Low
full	High

5.6 FACTORY_RESET

Applying a low signal on the FACTORY_RESET input for 5s restore the parameter data base to its default settings.

5.7 RF interface

The SPB800-B has a high performance chip antenna as the primary RF interface.

The SPB800-D has a U.FL connector as RF interface. Use Hirose U.FL receptacle or comparable for connection.

5.8 LED pins

The LED signal pins LED_1 and LED_2 and actively driven, active low signals. The pins are active low intended to sink the current for a LED connected to 3.3V via a current limiting resistor.

5.8.1 LED_1

The LED_1 signal will go low under these conditions:

- The SPB800 are associated with an Access Point (in station mode)
- While the SPB800 are switching between station and access point mode (after reset)
- Blinking with 2s interval indicating a failed firmware upgrade
- In AP mode when one or more stations are connected

5.8.2 LED_2

The LED_2 signal will go low under these conditions:

- The SPB800 has an IP-address, either set statically or assigned by a DHCP server
- In AP mode when a station is connected

5.9 General application information

5.9.1 Design directions

The design using the SPB800 must be performed according to good RF design considerations. Keep the area under the antenna free from all metal including signal or ground wires. To avoid connection with the test pads under the SPB800 no via or otherwise exposed metal should be placed under the module.

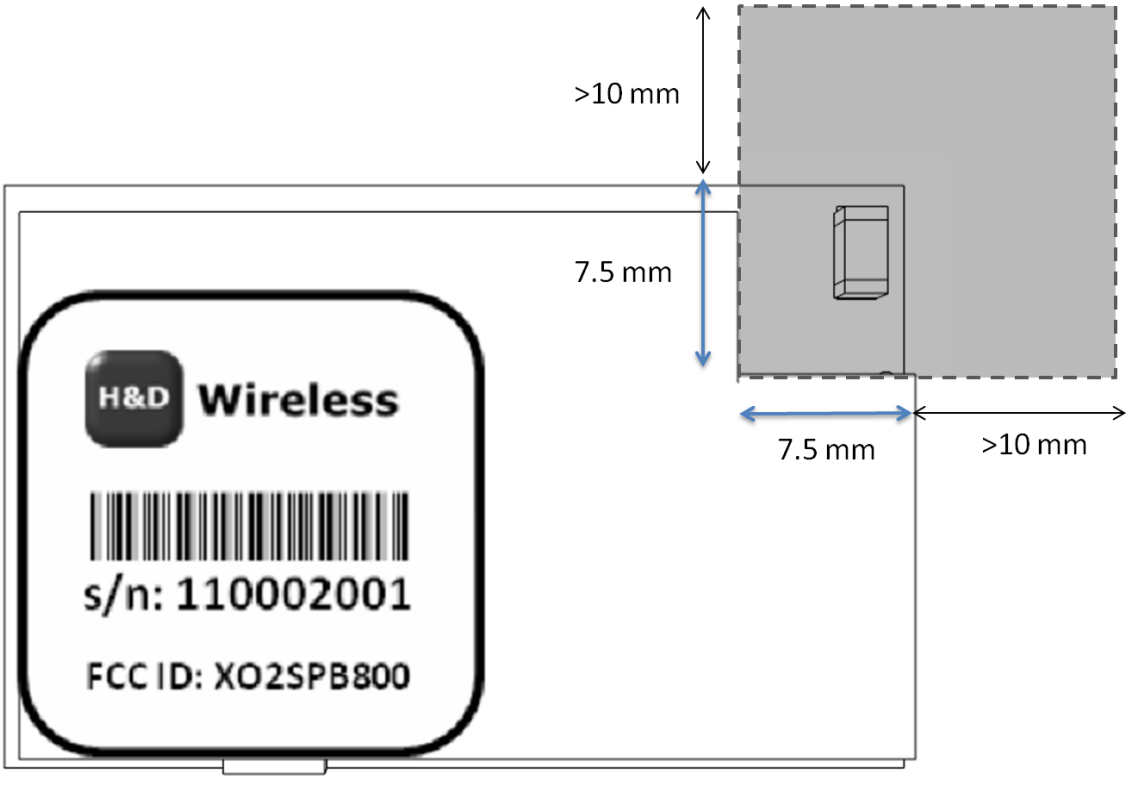


Figure 5-1: Proposed keep out area

5.10 Typical Application

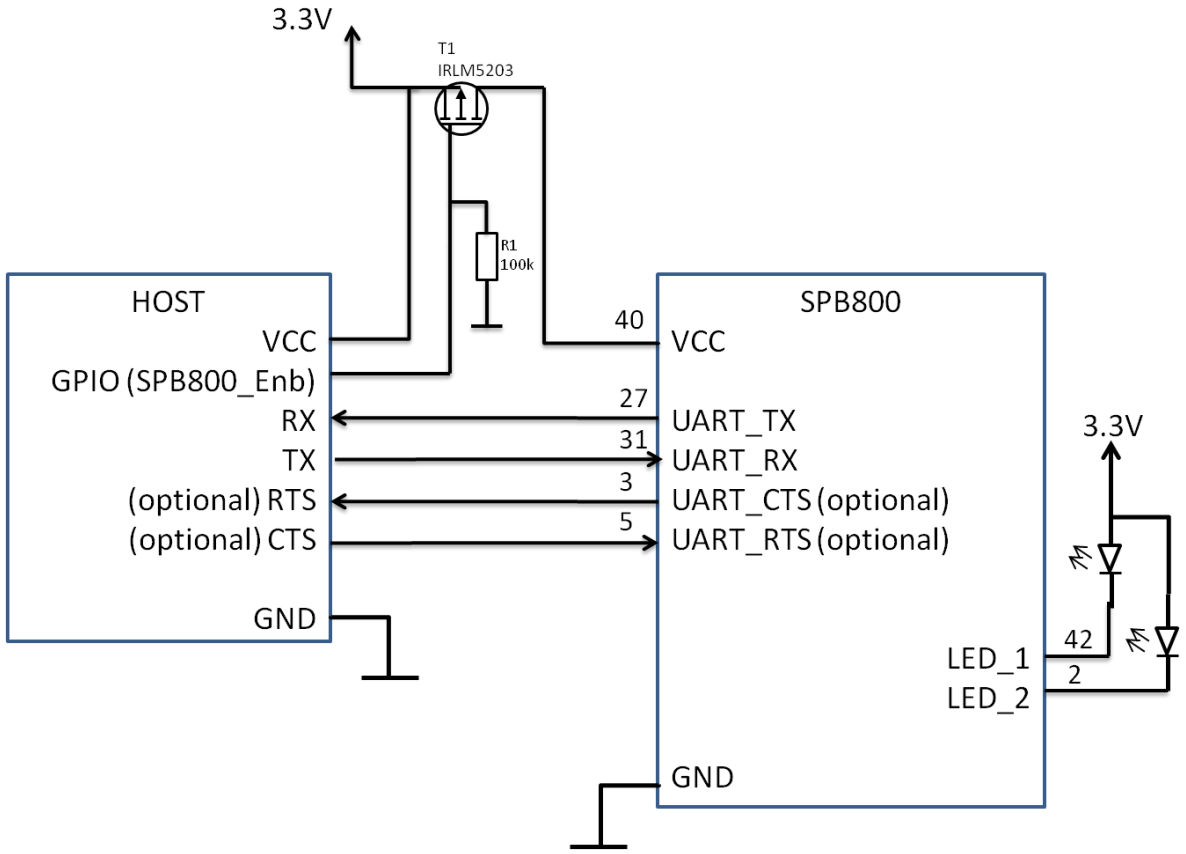


Figure 5-2: Application example connection directly to host

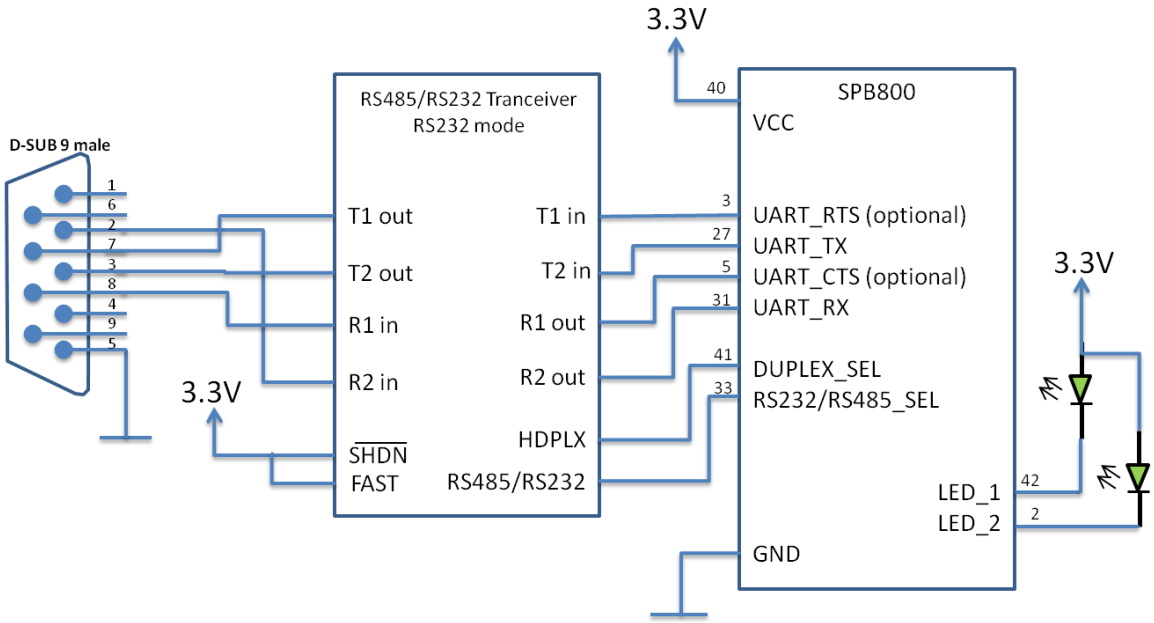


Figure 5-3: Application example with RS232 transceiver

5.11 Soldering

The SPB800 is a surface mount PCB module. If the modules has been exposed to air or are delivered in non-hermetically sealed packages it is recommended to bake the modules before soldering. To lower the moister content bake the packages for 192 hours at 40–45°C and <5%RH, or 24 hours at 120–130°C, depending on the maximum temperature rating of the packaging. The recommended solder profile is pictured in Figure 5.6

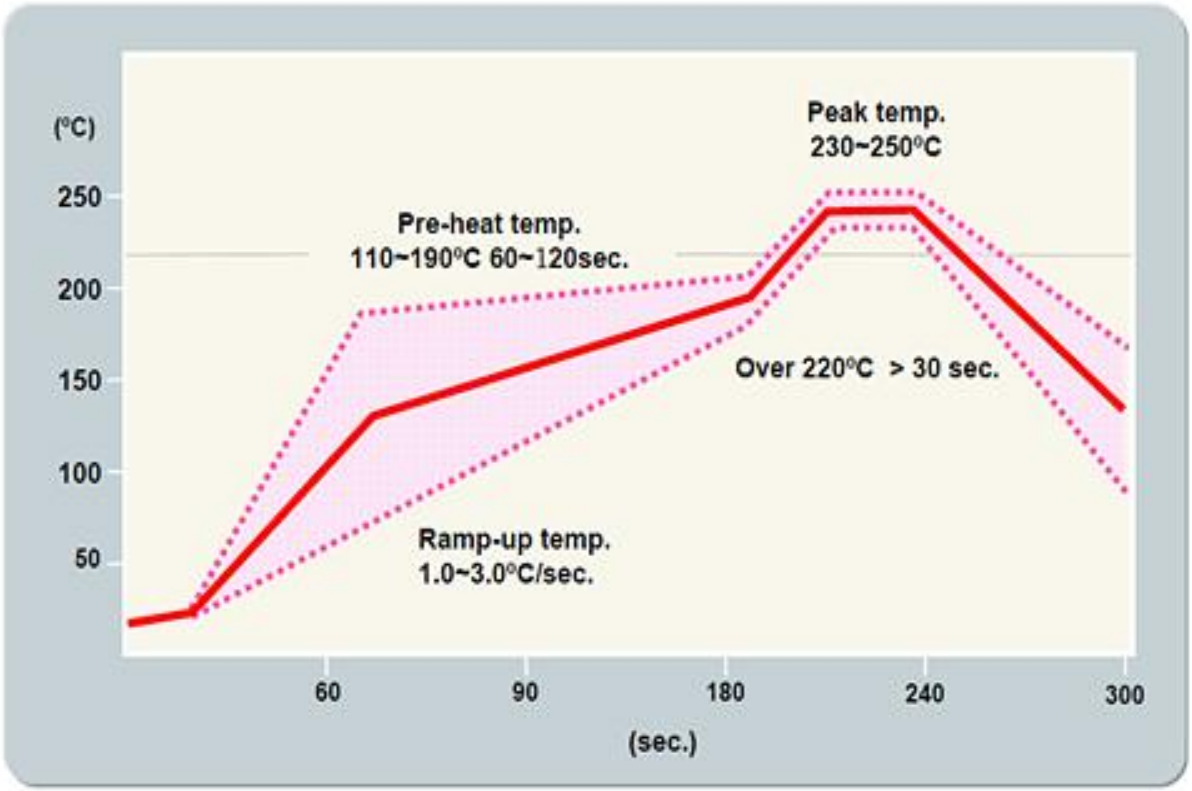


Figure 5.6: Reflow Temperture Profile.

Type	Rising Zone	Preheat Zone	Reflow Zone	Peak Zone	Cooldown Zone	Comment
PSR	125ºC-Peak No	110-190ºC 60-120 s	>220ºC >30 s	230-250ºC	Peak-125ºC No	

5.12 Environmental statement

The SPB800 is designed and manufactured to comply with the RoHS and Green directives.

6 PACKAGE SPECIFICATIONS

6.1 Mechanical outline of the SPB800 circuit board, bottom pads

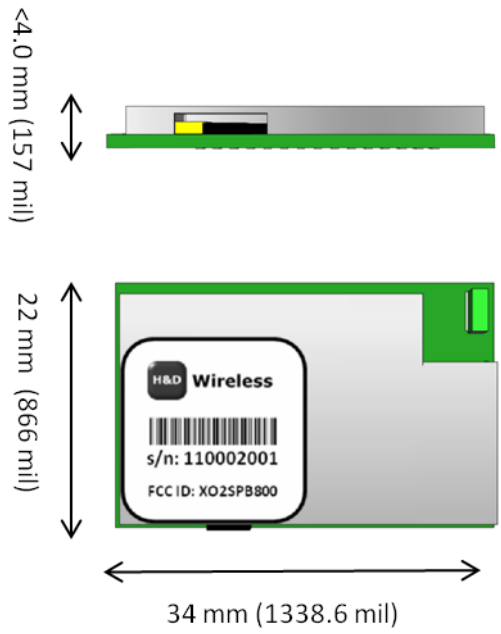


Figure 6-1: Mechanical drawing

6.2 Mechanical outline of the SPB800P module, 2x5 pin socket

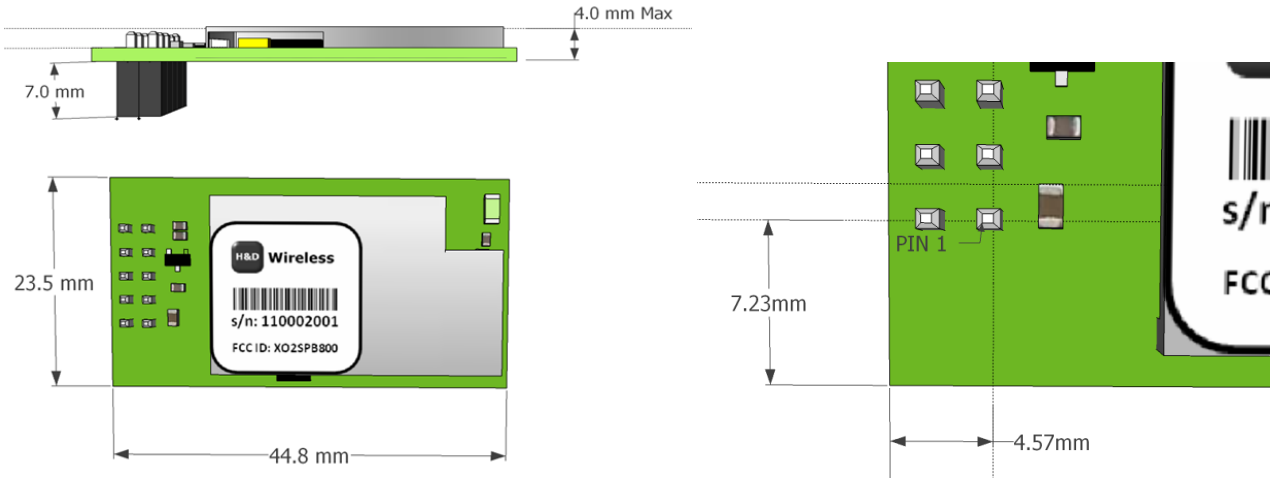


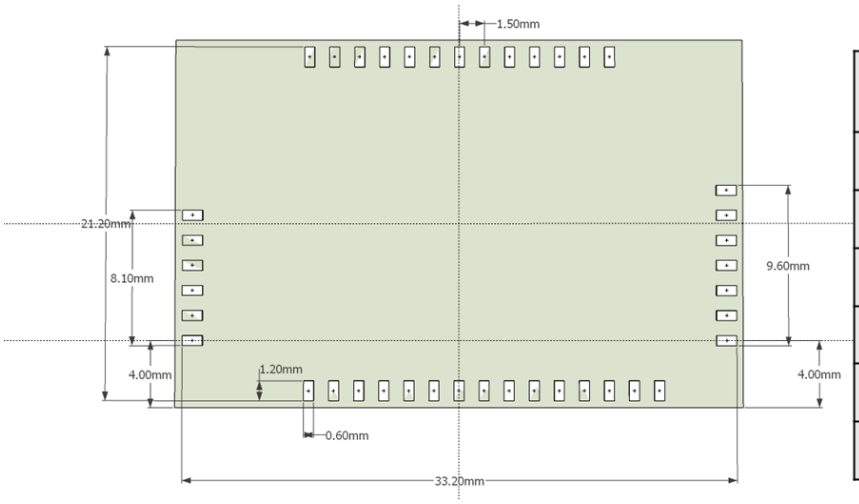
Figure 6-2: Mechanical drawing, SPB800P module with 2x5 pin socket

6.3 Markings on the SPB800

The label on the EMC Shield is imprinted with the FCC ID and part number and serial number.

6.4 Package dimensions

6.4.1 Pad positions



Symbol	Text	Meas [mm]
L	Module Length	34.0
W	Module Width	22.0
P1	Pad length	1.2
P2	Pad width	0.6
P3	Pad Pitch	1.5
A1	Pad edge to PCB edge	0.40

Figure 6-3: SPB800 Top View

6.5 Mounting information

Recommended land pattern on the PCB

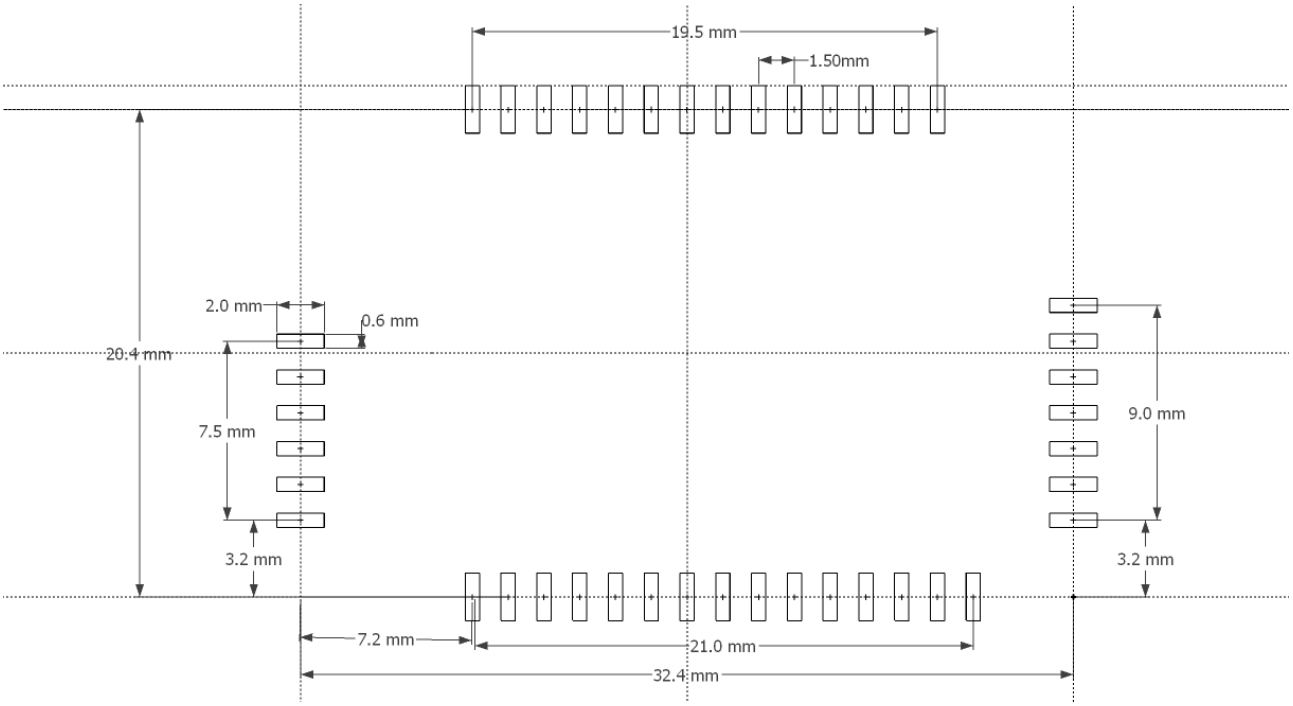
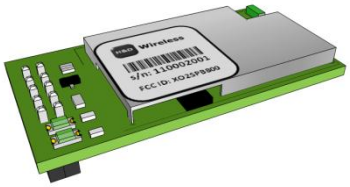


Figure 6-4: Land pattern for the SPB800 bottom pad version

7 Evaluation Kit

The SPB800E is delivered with Serial_to_WiFi firmware. To evaluate the SPB800P with oWL-pico server the SPB800E you must first shift the firmware with the HDA800 kit. See HDA800 manual and http://pico.hd-wireless.se for more information and downloads.

The Evaluation kit has the main signals of the SPB800 conveniently available on a 10 position header socket. The LED indicator signal are connected to two onboard LEDs. An additional ENb signal is an active low signal that enables power to the EVK. As the ENb has an onboard pull down resistance that will keep it low (active) it can be left unconnected. To shutdown the SPB800 the ENb signal has to be set high.



7.1 Pin out for the EVK (SPB800E)

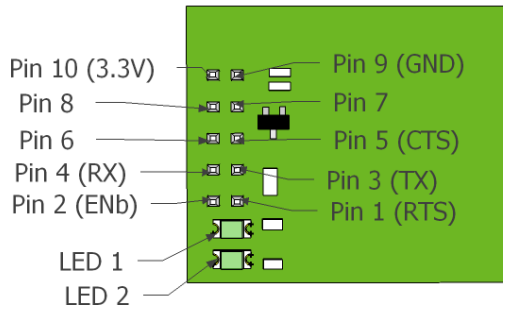


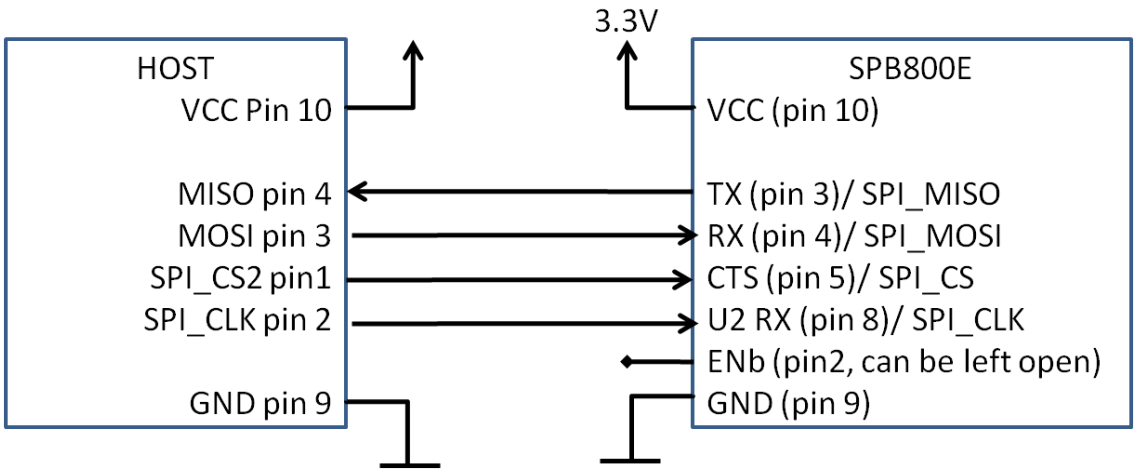
Figure 7-1: SPB800 EVK pins top view

Header Pin	Pin Function	SPB800 Pad	Comment
1	UART_RTS	5	Optional
2	ENb	-	Internal pull down can be left unconnected
3	UART_TX	27	
4	UART_RX	31	
5	UART_CTS	3	Optional
6	HOST_ATT	34	Host attention only available from Rev R2A
7	DEBUG_TX	25	Do not connect
8	DEBUG_RX	26	Do not connect
9	Ground	13, 14,16-23, 32	

10	Supply 3.3V	40	

Table 7-1: SPB800 Evaluation Kit pin out

To connect to a host MCU in UART mode follow the block diagram below:



8 STANDARDS COMPLIANCE

8.1 IEEE/IETF

Standard	Revision	Description
802.11	802.11™ -2007	WLAN MAC& PHY
802.11k	2008	Amendment 1: Radio Resource Measurement of Wireless LANs
802.11r	2008	Amendment 2: Fast Basic Service Set (BSS) Transition
RFC1023	Inherent	Frame encapsulation

Table 7.1: applicable IEEE standards

8.2 WiFi

Specification	Description	Revision
Wi-Fi 802.11b with WPA system inter operability test plan for IEEE 802.11b devices	802.11b devices with WPA	2.1
WiFi 802.11g with WPA system inter operability test plan	802.11g devices with WPA	2.0
WMM (including WMM Power Save)		Ver 1.1

Table 7.2: Applicable WiFi standards

8.3 Regulatory

Country	Approval authority	Regulatory	Frequency band
USA	FCC	FCC ID: XO2SPB800	2.4 GHz -2.4835 GHz
Canada	IC	RSS: 8713A-SPB800	2.4 GHz -2.4835 GHz
Europe	National	ETSI	2.4 GHz -2.4835 GHz

Table 7.3: Regulatory standards

8.3.1 FCC (United States of America)

This equipment complies with Part 15 of the FCC rules and regulations.
To fulfill FCC Certification requirements, an OEM manufacturer must comply with the following regulations:
1. The modular transmitter must be labeled with its own FCC ID number, and, if the FCC ID is not visible when the module is installed inside another device, then the outside of the device into which the module is installed must also display a label referring to the enclosed module. This exterior label can use wording such as the following:

Example of label required for OEM product containing SPB800 module

Contains FCC ID: XO2SPB800
The enclosed device complies with Part 15 of the FCC Rules. Operation is subject to the following two conditions: (i) this device may not cause harmful interference and (ii) this device must accept any interference received, including interference that may cause undesired operation.

2. To be used with the SPB800 module, only external antennas with a gain 2 dBi or less are allowed. The SPB800 Module may be integrated with custom design antennas which OEM installer must authorize following the FCC 15.21 requirements.

WARNING: The Original Equipment Manufacturer (OEM) must ensure that the OEM modular transmitter must be labeled with its own FCC ID number. This includes a clearly visible label on the outside of the final product enclosure that displays the contents shown below. If the FCC ID is not visible when the equipment is installed inside another device, then the outside of the device into which the equipment is installed must also display a label referring to the enclosed equipment.

IMPORTANT: This equipment complies with Part 15 of the FCC Rules. Operation is subject to the following two conditions: (1) this device may not cause harmful interference, and (2) this device must accept any interference received, including interference that may cause undesired operation (FCC 15.19).

The internal / external antenna(s) used for this mobile transmitter must provide a separation distance of at least 20 cm from all persons and must not be co-located or operating in conjunction with any other antenna or transmitter.

Installers must be provided with antenna installation instructions and transmitter operating conditions for satisfying RF exposure compliance. This device is approved as a mobile device with respect to RF exposure compliance, and may only be marketed to OEM installers. Use in portable exposure conditions (FCC 2.1093) requires separate equipment authorization.

IMPORTANT: Modifications not expressly approved by this company could void the user's authority to operate this equipment (FCC section 15.21).

IMPORTANT: This equipment has been tested and found to comply with the limits for a Class A digital device, pursuant to Part 15 of the FCC Rules. These limits are designed to provide reasonable protection against harmful interference when the equipment is operated in a commercial environment. This equipment generates, uses, and can radiate radio frequency energy and, if not installed and used in accordance with the instruction manual, may cause harmful interference to radio communications. Operation of this equipment in a residential area is likely to cause harmful interference in which case the user will be required to correct the interference at his own expense (FCC section 15.105).

8.3.2 IC (Canada)

Equipment is subject to certification under the applicable RSSs, shall be permanently labeled on each item, or as an inseparable combination. The label must contain the following information for full compliance:

Certification Number:	**IC: 8713A-SPB800**
Manufacturer's Name, Trade Name or Brand Name	**H&D Wireless AB**
Model Name:	**SPB800**

IMPORTANT: This equipment for which a certificate has been issued is not considered certified if it is not properly labeled. The information on the Canadian label can be combined with the manufacturer's other labeling requirements

IMPORTANT: Operation is subject to the following two conditions: (1) this device may not cause harmful interference, and (2) this device must accept any interference received, including interference that may cause undesired operation.

IMPORTANT: To reduce potential radio interference to other users, the antenna type and its gain should be so chosen that the equivalent isotropically radiated power (e.i.r.p.) is not more than that permitted for successful communication.

IMPORTANT: The installer of this radio equipment must ensure that the antenna is located or pointed such that it does not emit RF field in excess of Health Canada limits for the general population. Consult Safety Code 6, obtainable from Health Canada's website www.hc-sc.gc.ca/rpb.

8.3.3 ETSI (Europe)

The SPB800 module has been certified for use in European union countries according to ETSI EN 300 328 (Electromagnetic compatibility and Radio spectrum matters for equipment operating in the 2,4 GHz ISM band using spread spectrum modulation techniques). This standard is harmonized within the European Union and covering essential requirements under article 3.2 of the R&TTE-directive.

If the SPB800 module are incorporated into a product, the manufacturer must ensure compliance of the final end-user product to the European harmonized EMC and low voltage/safety standards. A declaration of conformity must be issued for the product including compliance references to these standards. Underlying the declaration of conformity a technical construction file (TCF), including all relevant test reports and technical documentation, must be issued and kept on file as described in Annex II of the R&TTE-directive.

Furthermore, the manufacturer must maintain a copy of the SPB800 module documentation and ensure the final product does not exceed the specified power ratings, antenna specifications, and/or installation requirements as specified in the user manual. If any of these specifications are exceeded in the final product, a complete re-test must be made in order to comply with all relevant standards as basis for CE-marking. A submission to notified body must be used only if deviations from standards have been found or if non-harmonized standards have been used.

9 Related Documents

1451- SPB800P Data Sheet
1543- HDA800_Users_Manual

10 SALES OFFICES

Global Sales Office Sweden

H&D Wireless AB
H&D Wireless AB
Norgegatan 1
164 32 Kista
Sweden

E-mail: info@hd-wireless.se
Support: support@hd-wireless.se
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Local sales offices and representatives see www.hd-wireless.se